

DESCRIPTION

The XA2163 is GaAs MMIC SPDT (Single Pole Double Throw) switch which was developed for 2.4 GHz and 6 GHz dual-band wireless LAN. This device can operate at frequencies from 0.5 to 2.5 GHz, 4.9 to 6.0 GHz and 8.0 GHz, with low insertion loss and high isolation.

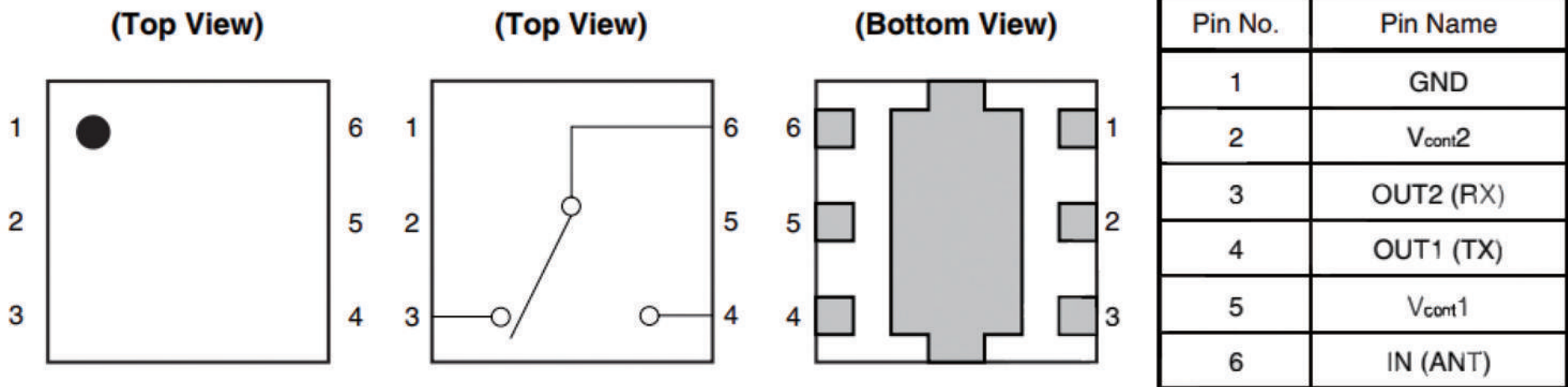
This device is housed in a 6-pin plastic TSON (Thin Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

FEATURES

- Operating frequency : f = 0.5 to 2.5 GHz, 4.9 to 6.0 GHz and 8.0 GHz
- Switch control voltage : $V_{\text{cont (H)}} = 2.8 \text{ to } 5.0 \text{ V (3.0 V TYP.)}$
: $V_{\text{cont (L)}} = -0.3 \text{ to } 0.3 \text{ V (0 V TYP.)}$
- Low insertion loss : $L_{\text{ins1}} = 0.40 \text{ dB TYP. @ } f = 2.4 \text{ to } 2.5 \text{ GHz}$
: $L_{\text{ins2}} = 0.50 \text{ dB TYP. @ } f = 4.9 \text{ to } 6.0 \text{ GHz}$
: $L_{\text{ins3}} = 0.90 \text{ dB TYP. @ } f = 8.0 \text{ GHz}$
: $L_{\text{ins4}} = 0.50 \text{ dB TYP. @ } f = 0.5 \text{ to } 2.5 \text{ GHz}$
- High isolation : $\text{ISL1} = 38 \text{ dB TYP. @ } f = 2.4 \text{ to } 2.5 \text{ GHz}$
: $\text{ISL2} = 30 \text{ dB TYP. @ } f = 4.9 \text{ to } 6.0 \text{ GHz}$
: $\text{ISL3} = 23 \text{ dB TYP. @ } f = 8.0 \text{ GHz}$
: $\text{ISL4} = 43 \text{ dB TYP. @ } f = 0.5 \text{ to } 1.0 \text{ GHz}$
: $\text{ISL5} = 38 \text{ dB TYP. @ } f = 1.0 \text{ to } 2.5 \text{ GHz}$
- Handling power : $P_{\text{in (1 dB)}} = +31.0 \text{ dBm TYP. @ } f = 2.5 \text{ GHz, } V_{\text{cont (H)}} = 3.0 \text{ V, } V_{\text{cont (L)}} = 0 \text{ V}$
: $P_{\text{in (1 dB)}} = +29.0 \text{ dBm TYP. @ } f = 6.0 \text{ GHz, } V_{\text{cont (H)}} = 3.0 \text{ V, } V_{\text{cont (L)}} = 0 \text{ V}$

XA2163 TSON6

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Remark Exposed pad : GND

TRUTH TABLE

V _{cont1}	V _{cont2}	IN (ANT)–OUT1 (TX)	IN (ANT)–OUT2 (RX)
High	Low	OFF	ON
Low	High	ON	OFF

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V _{cont}	–6.0 to +6.0	V
Input Power	P _{in}	+32	dBm
Operating Ambient Temperature	T _A	–45 to +85	°C
Storage Temperature	T _{stg}	–55 to +135	°C

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont (H)}	2.8	3.0	5.0	V
Switch Control Voltage (L)	V _{cont (L)}	–0.3	0	0.3	V
Operating Frequency 1 ^{Note 1}	f ₁	2.4	–	2.5	GHz
Operating Frequency 2 ^{Note 1}	f ₂	4.9	–	6.0	GHz
Operating Frequency 3 ^{Note 2}	f ₃	–	8.0	–	GHz
Operating Frequency 4 ^{Note 3}	f ₄	0.5	–	1.0	GHz
Operating Frequency 5 ^{Note 3}	f ₅	1.0	–	2.4	GHz

- Notes**
1. DC blocking capacitors = 4 pF
 2. DC blocking capacitors = 2 pF
 3. DC blocking capacitors = 100 pF

ELECTRICAL CHARACTERISTICS

($T_A = +25^\circ\text{C}$, $V_{\text{cont (H)}} = 3.0\text{ V}$, $V_{\text{cont (L)}} = 0\text{ V}$, $Z_0 = 50\ \Omega$, DC blocking capacitors = 4 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	L _{ins1}	f = 2.4 to 2.5 GHz	–	0.40	0.60	dB
Insertion Loss 2	L _{ins2}	f = 4.9 to 6.0 GHz	–	0.50	0.80	dB
Insertion Loss 3	L _{ins3}	f = 8.0 GHz ^{Note 1}	–	0.90	–	dB
Insertion Loss 4	L _{ins4}	f = 0.5 to 2.5 GHz ^{Note 2}	–	0.50	–	dB
Isolation 1	ISL1	f = 2.4 to 2.5 GHz	35	38	–	dB
Isolation 2	ISL2	f = 4.9 to 6.0 GHz	27	30	–	dB
Isolation 3	ISL3	f = 8.0 GHz ^{Note 1}	–	23	–	dB
Isolation 4	ISL4	f = 0.5 to 1.0 GHz ^{Note 2}	40	43	–	dB
Isolation 5	ISL5	f = 1.0 to 2.5 GHz ^{Note 2}	35	38	–	dB
Input Return Loss 1	RL _{in1}	f = 2.4 to 2.5 GHz	–	15	–	dB
Input Return Loss 2	RL _{in2}	f = 4.9 to 6.0 GHz	–	15	–	dB
Input Return Loss 3	RL _{in3}	f = 8.0 GHz ^{Note 1}	–	15	–	dB
Input Return Loss 4	RL _{in4}	f = 0.5 to 2.5 GHz ^{Note 2}	–	20	–	dB
Output Return Loss 1	RL _{out1}	f = 2.4 to 2.5 GHz	–	15	–	dB
Output Return Loss 2	RL _{out2}	f = 4.9 to 6.0 GHz	–	15	–	dB
Output Return Loss 3	RL _{out3}	f = 8.0 GHz ^{Note 1}	–	15	–	dB
Output Return Loss 4	RL _{out4}	f = 0.5 to 2.5 GHz ^{Note 2}	–	20	–	dB
1 dB Loss Compression Input Power 1 ^{Note 3}	P _{in (1 dB) 1}	f = 2.4 to 2.5 GHz	–	+31.0	–	dBm
1 dB Loss Compression Input Power 2 ^{Note 3}	P _{in (1 dB) 2}	f = 4.9 to 6.0 GHz	–	+29.0	–	dBm
Input 3rd Order Intercept Point	IIP ₃		–	+55	–	dBm
Switch Control Current	I _{cont}		–	0.1	1.0	μA
Switch Control Speed	t _{sw}	50% CTL to 90/10%	–	50	–	ns

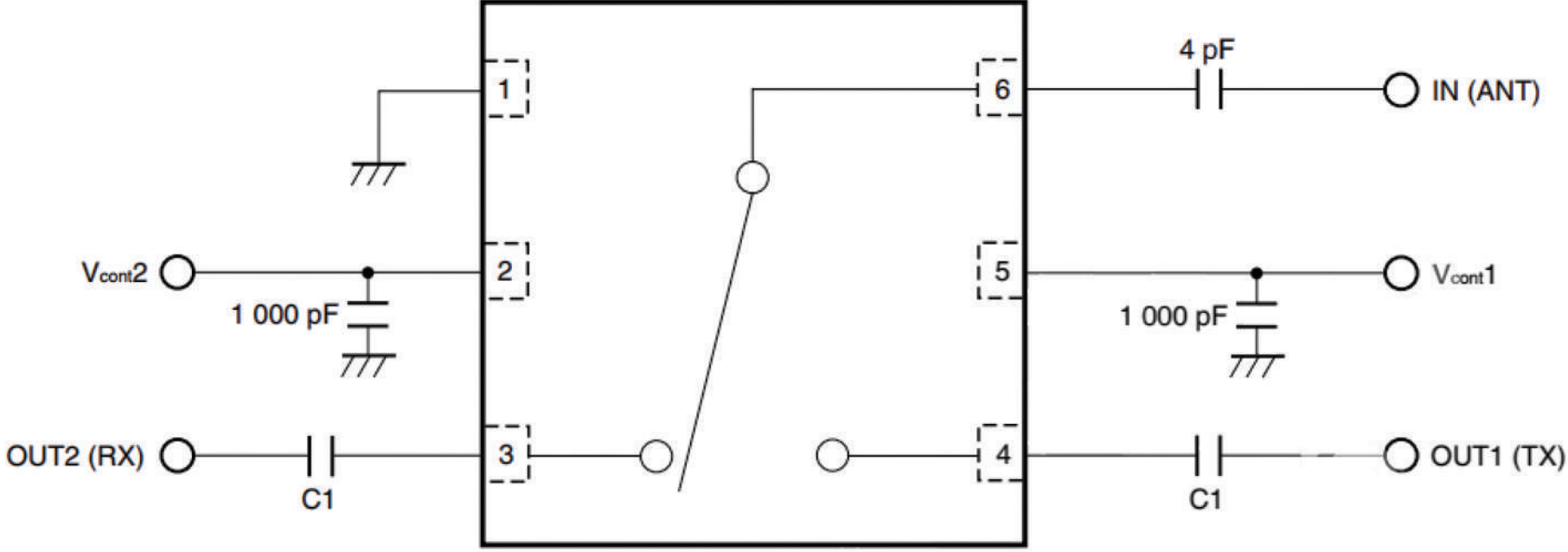
Notes 1. DC blocking capacitors = 2 pF

2. DC blocking capacitors = 100 pF

3. P_{in (1 dB)} is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC blocking capacitors.

EVALUATION CIRCUIT



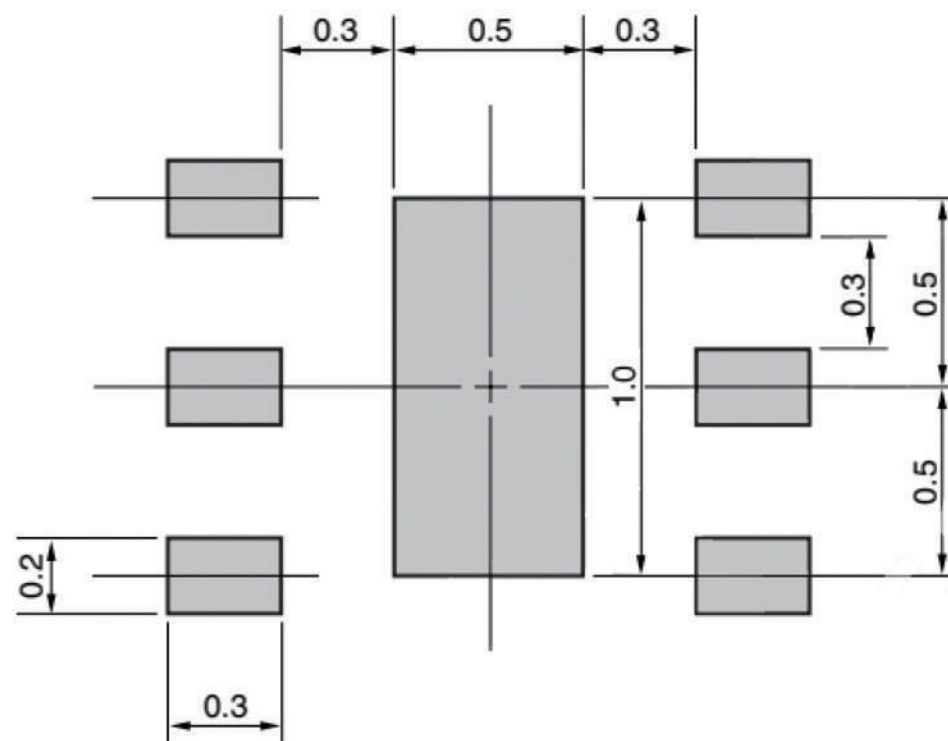
Remark C1: 2.4 to 2.5 GHz and 4.9 to 6.0 GHz 4 pF
 8.0 GHz 2 pF
 0.5 to 2.5 GHz 100 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

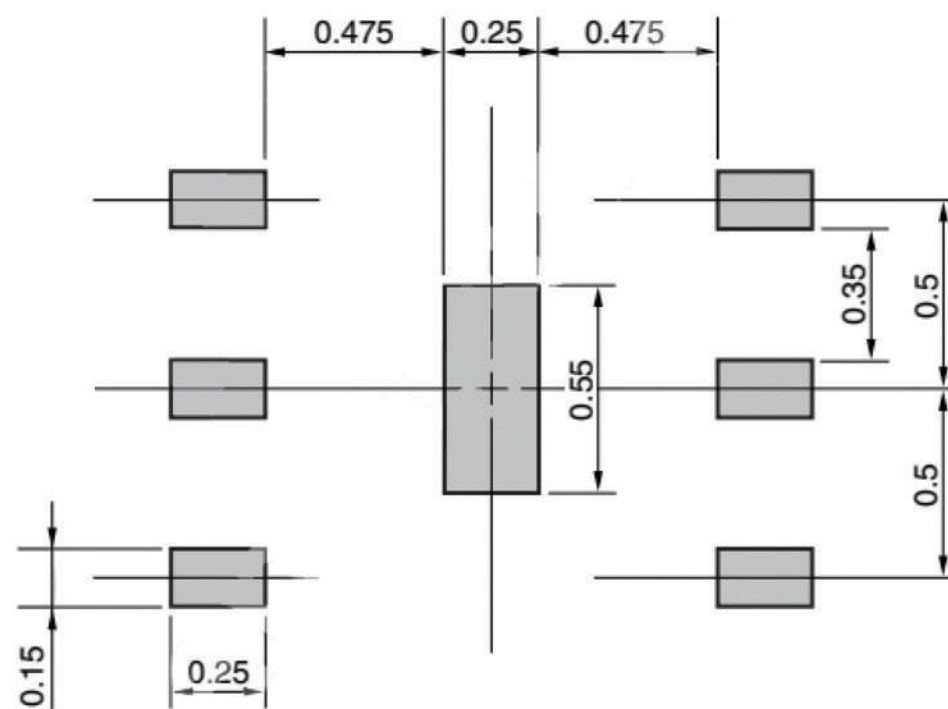
MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)

MOUNTING PAD



SOLDER MASK



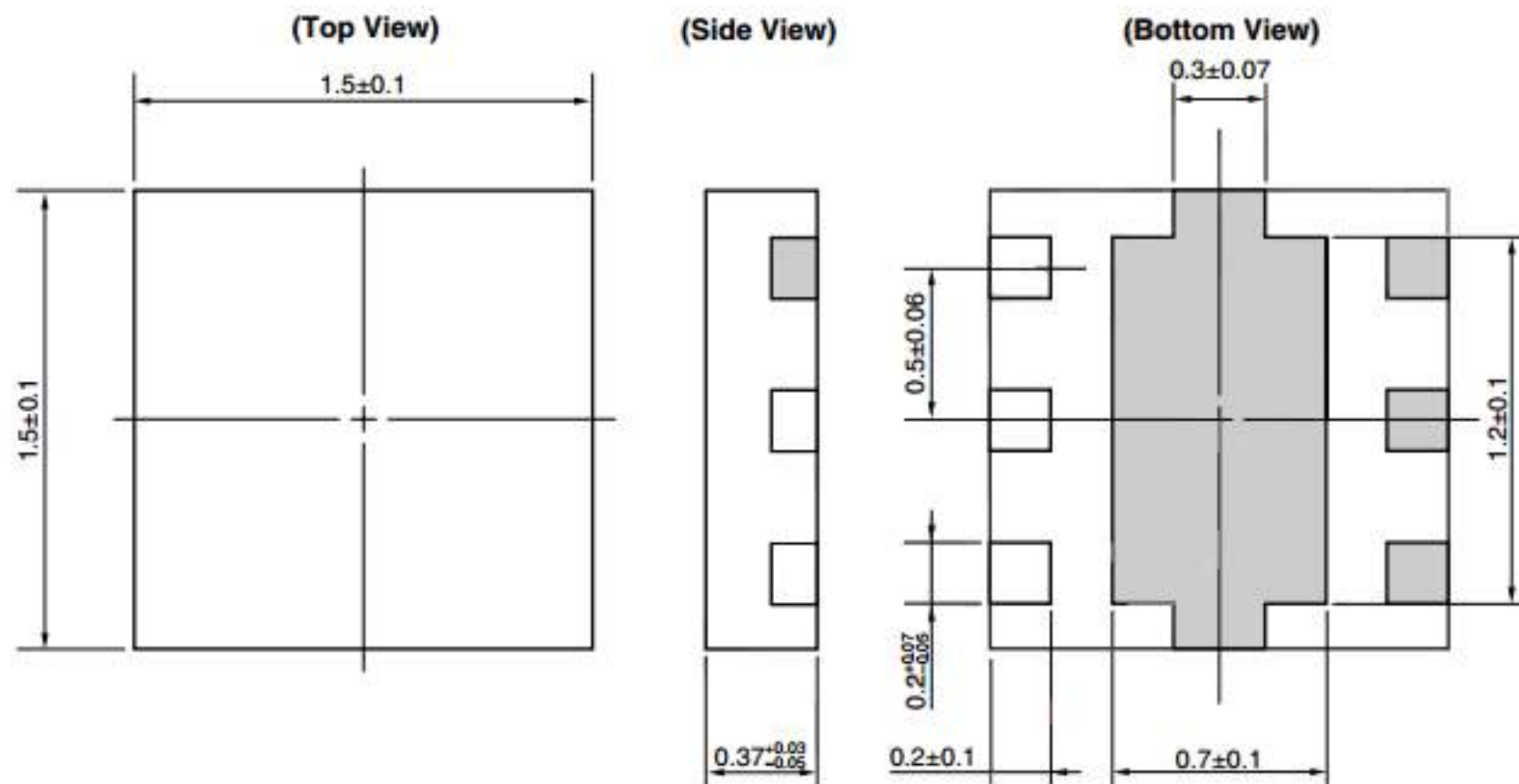
Solder thickness : 0.08 mm

Remark The mounting pad and solder mask layouts in this document are for reference only. When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

RECOMMENDED SOLDERING CONDITIONS

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



以上信息仅供参考. 如需帮助联系客服人员. 谢谢 XINLUDA